## **BGA Heat Sink - High Performance ASIC Cooling**





ATS Part#: ATS-56011-C4-R0

Description: 57.50 x 57.50 x 12.50 mm BGA Heat Sink - High Performance ASIC Cooling

Heat Sink Type: ASIC Cooling
Heat Sink Attachment: Thermal Tape

Equivalent Part Number: N/A

## **Features & Benefits**

- maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- Designed specifically for ASIC package and their unique cooling requirements

## **Thermal Performance**

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	2.3 °C/W	1.8 °C/W	1.3 °C/W	1.2 °C/W	1 °C/W	0.8 °C/W	0.7 °C/W
	Ducted Flow	1.1	N/A	N/A	N/A	N/A	N/A	N/A

## **Product Detail**

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
	57.50 mm	57.50 mm	12.50 mm	70 mm	NO TIM	BLACK-ANODIZED
	<ul> <li>Dimension</li> <li>Thermal application</li> <li>ATS reserver</li> <li>ATS certification</li> </ul>	erves the right to up	height from the booker provided for reference date or change its princh assembly is Rol	prence only. Actual products without no	performance	may vary by
*Image above is for illustration purpose only.						



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